



CHENMKO ENTERPRISE CO.,LTD

Halogens free devices

**SURFACE MOUNT
PNP SILICON Transistor**

VOLTAGE 60 Volts CURRENT 3 Ampere

CHT2955ZGP

APPLICATION

- * Telephony and professional communication equipment.
- * Other switching applications.

FEATURE

- * Small flat package. (SC-73/SOT-223)
- * Suitable for high packing density.
- * High saturation current capability.

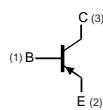
CONSTRUCTION

* PNP SILICON Transistor

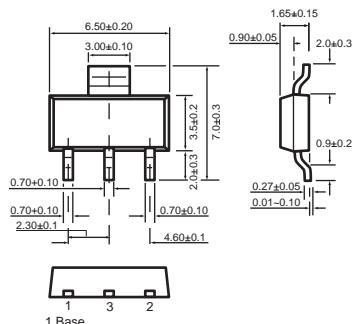
MARKING

* ZDP

CIRCUIT



SC-73/SOT-223



1 Base
2 Emitter
3 Collector (Heat Sink)

Dimensions in millimeters

SC-73/SOT-223

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	—	-100	V
V_{CEO}	collector-emitter voltage	open base	—	-60	V
V_{EBO}	emitter-base voltage	open collector	—	-7.0	V
I_C	collector current (DC)		—	-6.0	A
I_B	Base Current		—	-3.0	A
P_{tot}	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$; note 1	—	2	W
T_{stg}	storage temperature		-65	+150	$^\circ\text{C}$
T_j	junction temperature		—	150	$^\circ\text{C}$
T_{amb}	operating ambient temperature		-65	+150	$^\circ\text{C}$

Note

1. Transistor mounted on an FR4 printed-circuit board.

RATING CHARACTERISTIC CURVES (CHT2955ZGP)

CHARACTERISTICS

$T_{amb} = 25^{\circ}\text{C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I_{CEO}	collector cut-off current	$V_{CE}=-30\text{ V}$	–	-700	uA
I_{EBO}	emitter cut-off current	$V_{EB}=-7.0\text{V}$	–	-5.0	mA
h_{FE}	DC current gain	$I_C = -4.0\text{A}; V_{CE} = -4\text{V}$ $I_C = -6.0\text{A}; V_{CE} = -4\text{V}$	20 5.0	70 –	
V_{CEsat}	collector-emitter saturation voltage	$I_C = -4.0\text{A}, I_B = -400\text{mA}$	–	-1.1	V
V_{BEON}	base-emitter saturation voltage	$I_C = -4.0\text{A}; V_{CE} = -4\text{V}$	–	-1.5	V
f_T	transition frequency	$I_C = -500\text{mA}; V_{CE} = 10\text{ V};$ $f = 1.0\text{MHz}$	2.5	–	MHz